

## **Supplemental Application Data Sheet**

### **Application Information**

Application number::	10/541,325
Filing Date::	11/02/05
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	METHOD FOR DISTRIBUTING DYNAMIC LINK BANDWIDTH FOR RESILIENT PACKET RING
Attorney Docket Number::	16663-00001-US
Request for Early Publication?::	No
Request for Non-Publication?::	No
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

### **Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	People's Republic of China
Status::	Full Capacity
Given Name::	Li
Family Name::	Mo
City of Residence::	Shenzhen City
Country of Residence::	People's Republic of China
Street of mailing address::	ZTE Plaza, Keith Road South

City of mailing address:: Hi-Tech Industrial Park; Guangdong Province  
Shenzhen City  
Country of mailing address:: People's Republic of China  
Postal or Zip Code of mailing address:: 518057

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: People's Republic of China  
Status:: Full Capacity  
Given Name:: Xuefei  
Family Name:: Wei  
City of Residence:: Shenzhen  
Country of Residence:: People's Republic of China  
Street of mailing address:: ZTE Plaza, Keith Road South  
Hi-Tech Industrial Park; Guangdong Province  
City of mailing address:: Shenzhen City  
Country of mailing address:: People's Republic of China  
Postal or Zip Code of mailing address:: 518057

#### **Correspondence Information**

Correspondence Customer Number:: 23416

#### **Representative Information**

Representative Customer Number:: 23416

#### **Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/CN03/00002	01/02/03

#### **Foreign Priority Information**

**Assignee Information**

Assignee name::	ZTE Corporation
Street of mailing address::	ZTE Plaza
	Keji Road South, Hi Tech Industrial Park
City of mailing address::	Nanshan District, Shenzhen, Guangdong
Country of mailing address::	People's Republic of China
Postal or Zip Code of mailing address::	518057